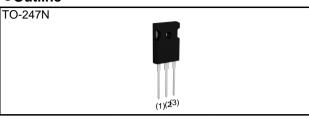


# SCT4013DE

N-channel SiC power MOSFET

V <sub>DSS</sub>	750V
R <sub>DS(on)</sub> (Typ.)	13mΩ
Ι <sub>D</sub> <sup>*1</sup>	105A
P <sub>D</sub>	312W

#### Outline



#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

#### Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating

●Inner circuit	
(1) o (1) o (1) o (1) Gate (2) Drain (3) Source *1 Body Diode	

#### Packaging specifications

	Packing	Tube
	Reel size (mm)	-
Tuno	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	30
	Taping code	C11
	Marking	SCT4013DE

#### •Absolute maximum ratings (T<sub>vj</sub> = 25°C unless otherwise specified.)

Parameter			Symbol	Value	Unit
Drain - source voltage		V <sub>DSS</sub>	750	V	
Continuous drain	V - V	$T_c = 25^{\circ}C$	*1	105	А
and source current	$V_{GS} = V_{GS_{on}}$	$T_c = 100^{\circ}C$	۰ ا <sub>D</sub> , I <sub>S</sub> <sup>*1</sup>	74	А
Pulsed drain current	$V_{GS} = V_{GS_{on}}$	$T_c = 25^{\circ}C$	I <sub>D,pulse</sub> *2	233	А
Body diode pulsed forwa	ard current	$T_c = 25^{\circ}C$	*1,*3 I <sub>S,pulse</sub>	105	А
Body diode surge forward current		$V_{GS} = 0 V$	I <sub>S,pulse</sub> *1,*4	233	А
Gate - source voltage (DC)		V <sub>GSS_DC</sub>	-4 to +21	V	
Gate - source surge volt	tage (t <sub>surge</sub> < 300	)ns)	$V_{GSS\_surge}$ *5	-4 to +23	V
Recommended turn-on gate - source drive voltage		V <sub>GS_on</sub> *6	+15 to +18	V	
Recommended turn-off gate - source drive voltage		V <sub>GS_off</sub>	0	V	
Virtual junction temperature		T <sub>vj</sub>	175	°C	
Range of storage temperature		T <sub>stg</sub>	-40 to +175	°C	

### •Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

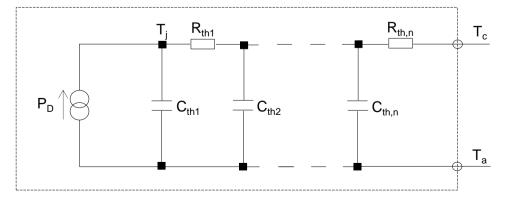
Deremeter	Curren al	Conditions	Values			L Locit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown	V	$V_{GS} = 0 V, I_{D} = 18.6 mA$				V	
voltage	V <sub>(BR)DSS</sub>	T <sub>vj</sub> = 25°C	750	-	-	v	
		$V_{GS} = 0 V, V_{DS} = 750V$					
Zero Gate voltage Drain current	I <sub>DSS</sub>	T <sub>vj</sub> = 25°C	-	1	80	μA	
		T <sub>vj</sub> = 150°C	-	10	-		
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS}$ = +21V , $V_{DS}$ = 0V	-	-	100	nA	
Gate - Source leakage current		$V_{GS} = -4V$ , $V_{DS} = 0V$	-	-	-100	nA	
Gate threshold voltage	$V_{GS(th)}$ *7	$V_{DS} = 10V, I_{D} = 30.8mA$	2.8	-	4.8	V	
		$V_{GS} = 18V, I_{D} = 58A$					
Static Drain - Source on - state resistance	R <sub>DS(on)</sub> *8	T <sub>vj</sub> = 25°C	-	13.0	16.9	mΩ	
		T <sub>vj</sub> = 150°C	-	22.2	-		
Gate input resistance	$R_G$	f = 1MHz, open drain	-	1	-	Ω	

#### Thermal resistance

Paramotor	Symbol	Values			Unit
Parameter		Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	${\sf R_{thJC}}^{*9}$	-	0.37	0.48	K/W

#### •Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R <sub>th1</sub>	4.0 ×10 <sup>-2</sup>		C <sub>th1</sub>	1.2 ×10 <sup>-3</sup>	
R <sub>th2</sub>	1.6 ×10 <sup>-1</sup>	K/W	C <sub>th2</sub>	4.6 ×10 <sup>-3</sup>	Ws/K
R <sub>th3</sub>	1.7 ×10 <sup>-1</sup>		C <sub>th3</sub>	2.6 ×10 <sup>-2</sup>	





# •Electrical characteristics ( $T_{vj}$ = 25°C unless otherwise specified)

Deremeter	O maked	Symbol Conditions -		Values			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Transconductance	<b>g</b> <sub>fs</sub> *8	$V_{DS} = 10V, I_{D} = 58A$	-	32	-	S	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0V$	-	4580	-	pF	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 500V	-	203	-		
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	10	-		
Effective output capacitance, energy related	C <sub>o(er)</sub>	$V_{GS} = 0V$ $V_{DS} = 0V$ to 500V	-	263	-	pF	
Total Gate charge	Q <sub>g</sub> *8	$V_{DS} = 500V$ $I_{D} = 58A$	-	170	-		
Gate - Source charge	Q <sub>gs</sub> *8	V <sub>GS</sub> = 18V	-	39	-	nC	
Gate - Drain charge	Q <sub>gd</sub> *8	See Fig. 1-1, 1-2.	-	42	-		
Turn - on delay time	t <sub>d(on)</sub> *8	$V_{DS} = 500V$ $I_{D} = 58A$	-	20	-		
Rise time	t <sub>r</sub> *8	V <sub>GS</sub> = +18V / 0V	-	57	-	ns	
Turn - off delay time	t <sub>d(off)</sub> *8	$R_G = 6.8\Omega$ , L = 250µH E <sub>on</sub> includes diode	-	83	-	113	
Fall time	$t_{f}^{*8}$ reverse recovery - 21 $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF				-		
Turn - on switching loss	E <sub>on</sub> *8	See Fig. 2-1, 2-2, 2-3.	-	1100	-	μJ	
Turn - off switching loss	E <sub>off</sub> *8		-	630	-	μο	
Short-circuit	• t <sub>sc</sub> *9	V <sub>DS</sub> ≤ 400V V <sub>DS,peak</sub> ≤ 750V	-	12.0	-	μs	
withstand time $V_{GS(on)} = +18V$		$T_{vj(start)} = 25^{\circ}C$ $R_{G} = 2.2\Omega$	-	11.5	-	μs	



#### •Body diode electrical characteristics (Source-Drain) (T<sub>vi</sub> = 25°C unless otherwise specified)

Doromotor	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Forward voltage	$V_{SD}^{*8}$	$V_{GS} = 0V, I_S = 58A$	-	3.3	-	V	
Reverse recovery time	t <sub>rr</sub> *8	$I_F = 58A$ $V_R = 500V$	-	47	-	ns	
Reverse recovery charge	Q <sub>rr</sub> *8	di/dt = 1700A/µs	-	420	-	nC	
Peak reverse recovery current	I <sub>rrm</sub> *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	18	-	А	

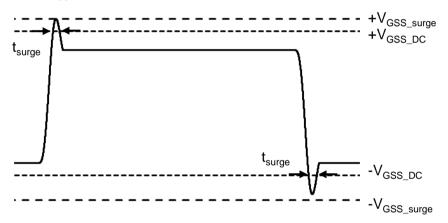
\*1 Limited by maximum  $T_{vi}$  and for Max.  $R_{thJC}$ .

\*2 Pulse width and duty cycle are limited by  $T_{vj,max}$ .

\*3 Only for body-diode, Repititive pulse, PW  $\leq$  1.5µs, Duty cycle  $\leq$  5%

\*4 When used as a protective function, PW  $\leq$  10µs

\*5 Example of acceptable V<sub>GS</sub> waveform

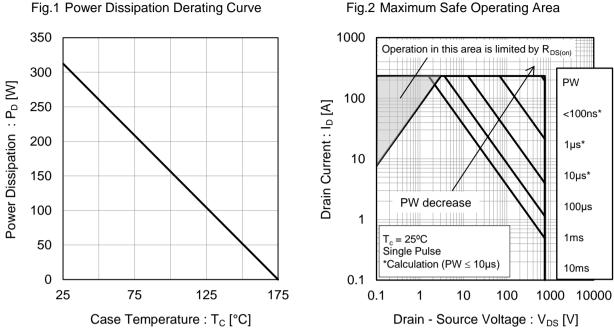


- \*6 Please be advised not to use SiC-MOSFETs with V<sub>GS</sub> below 10V as doing so may cause thermal runaway.
- \*7 Tested after applying  $V_{GS}$  = 21V for 100ms.
- \*8 Pulsed
- \*9 The value is based on TO-247 package. Single Pulsed.
- \*10 Measured conformable to JESD51-14.

See the application note "rthjc\_measurement\_and\_usage\_an-e.pdf". Link

URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc\_measurement\_and\_usage\_an-e.pdf





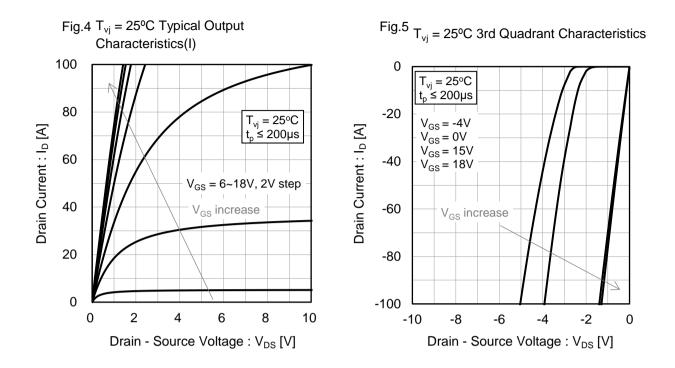


#### Impedance vs. Pulse Width 1 Transient Thermal Impedance : 0.1 Duty = 1 Z<sub>thJC</sub> [K/W] 0.5 0.01 0.2 Duty increase 0.1 0.05 0.001 0.02 0.01 Single pulse $T_c = 25^{\circ}C$ 0.0001 1E-6 1E-5 1E-4 1E-3 1E-2 1E-1 1E+0 1E+1

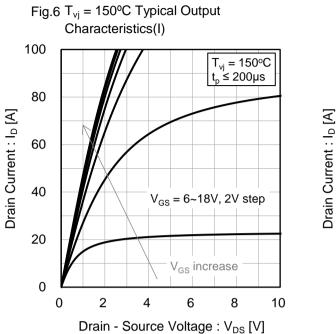
Fig.3 Typical Transient Thermal

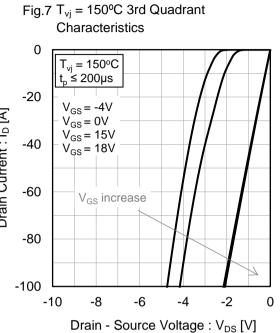
# Pulse Width : PW [s]

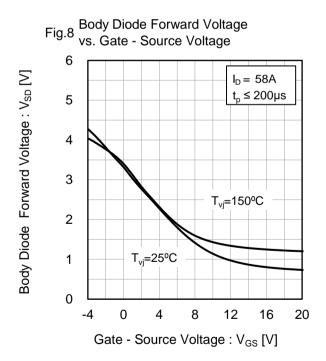














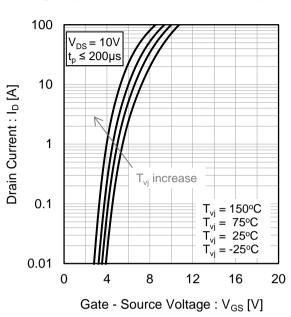
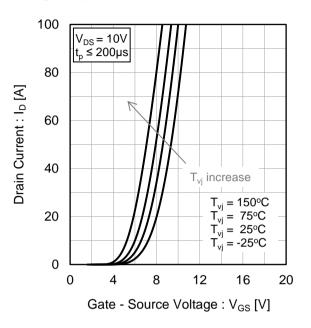


Fig.9 Typical Transfer Characteristics (I)

Fig.10 Typical Transfer Characteristics (II)



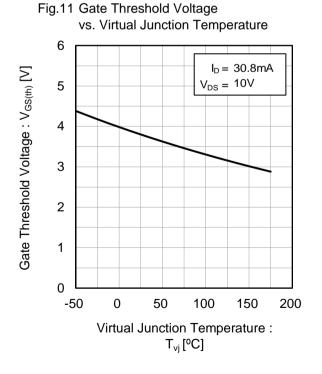
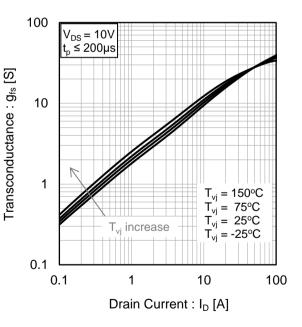
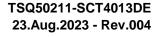


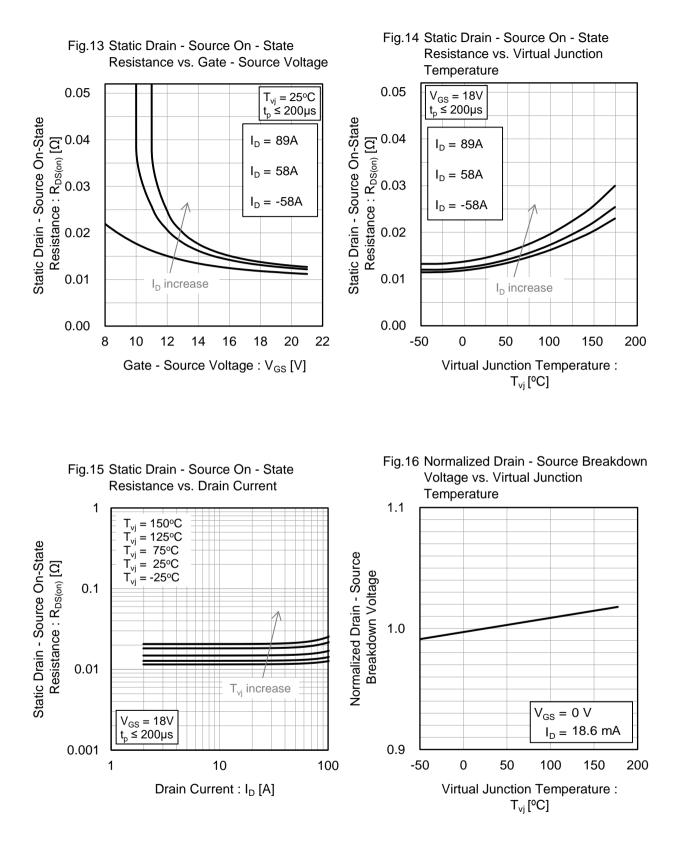
Fig.12 Transconductance vs. Drain Current



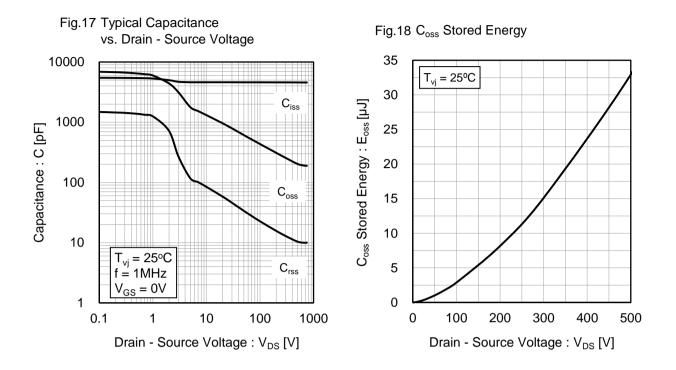


ROHM

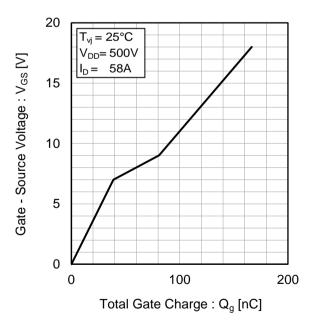




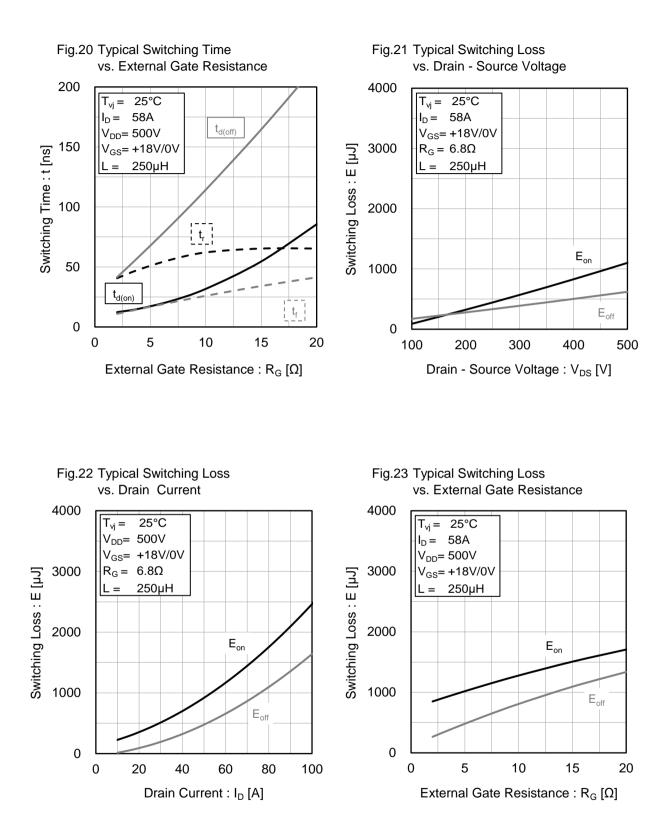




#### Fig.19 Dynamic Input Characteristics









#### Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

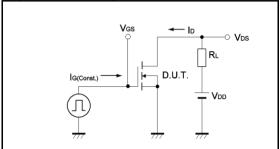
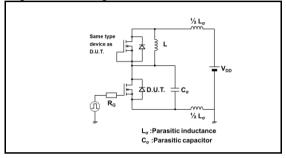


Fig.2-1 Switching Characteristics Measurement Circuit



#### Fig.2-3 Waveforms for Switching Energy Loss

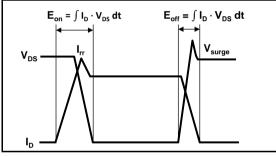
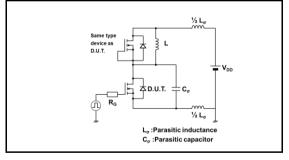
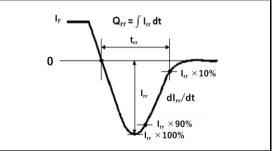


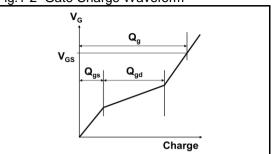
Fig.3-1 Reverse Recovery Time Measurement Circuit



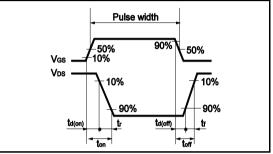
#### Fig.3-2 Reverse Recovery Waveform



#### Fig.1-2 Gate Charge Waveform

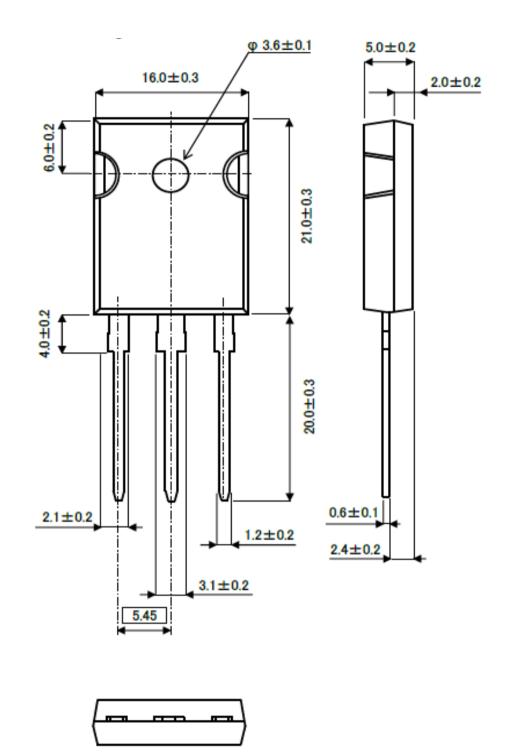








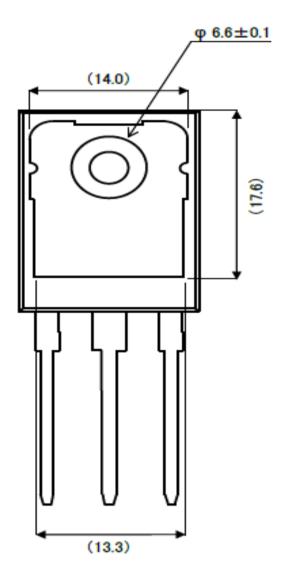
#### • Package Dimensions



Unit: mm





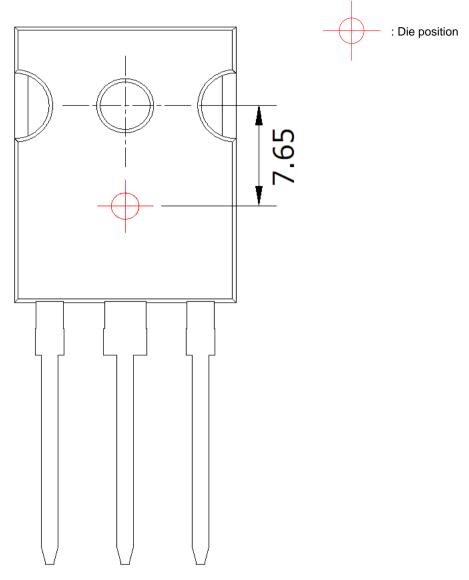


Unit: mm





#### Die Bonding Layout



•Front view of the packaging.

•Dimensions are design values.

·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm





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